

## P6803HVG-VB Datasheet

# **Dual N-Channel 30-V (D-S) MOSFET**

| PRODUCT SUMMARY     |  |                    |                       |  |  |
|---------------------|--|--------------------|-----------------------|--|--|
| V <sub>DS</sub> (V) | $R_{DS(on)}(\Omega)$                     | I <sub>D</sub> (A) | Q <sub>g</sub> (Typ.) |  |  |
| 30                  | $0.022 \text{ at V}_{GS} = 10 \text{ V}$ | 6.8                | 15 nC                 |  |  |
| 30                  | 0.026 at V <sub>GS</sub> = 4.5 V         | 6.0                | 15110                 |  |  |

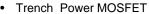
 $D_1$ 

 $D_2$ 

SO-8

Top View

#### **FEATURES** Halogen-free According to IEC 61249-2-21 Definition



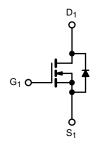
- 100 % UIS Tested
- 100 %  $R_g$  Tested
- Compliant to RoHS Directive 2002/95/EC

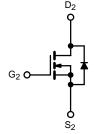


COMPLIANT HALOGEN **FREE** 

#### **APPLICATIONS**

- Set Top Box
- Low Current DC/DC





N-Channel MOSFET

N-Channel MOSFET

| Parameter   | Symbol                      | Limit                             | Unit                 |    |  |
|---|-----------------------------|-----------------------------------|----------------------|----|--|
| Drain-Source Voltage                                |                             | V <sub>DS</sub>                   | 30                   | V  |  |
| Gate-Source Voltage                                 |                             | $V_{GS}$                          | ± 20                 | V  |  |
|   | T <sub>C</sub> = 25 °C      |                                   | 6.8 <sup>a</sup>     |    |  |
| Continuous Drain Current (T <sub>.I</sub> = 150 °C) | T <sub>C</sub> = 70 °C      | I                                 | 5.6                  |    |  |
| Continuous Diam Current (1) = 130 C)                | T <sub>A</sub> = 25 °C      | l <sub>D</sub>                    | 6.2 <sup>b, c</sup>  |    |  |
|   | T <sub>A</sub> = 70 °C      |                                   | 5.2 <sup>b, c</sup>  | Α  |  |
| Pulsed Drain Current                                |                             | I <sub>DM</sub>                   | 30                   | A  |  |
| Continuous Source-Drain Diode Current               | T <sub>C</sub> = 25 °C      | l-                                | 2.25                 |    |  |
| Continuous Source-Drain Diode Current               | T <sub>A</sub> = 25 °C      | ls –                              | 1.48 <sup>b, c</sup> |    |  |
| Single Pulse Avalanche Current                      | L = 0.1 mH                  | I <sub>AS</sub>                   | 5                    |    |  |
| Single Pulse Avalanche Energy                       | L=0.1 IIII                  | E <sub>AS</sub>                   | 1.25                 | mJ |  |
|   | T <sub>C</sub> = 25 °C      |                                   | 2.7                  |    |  |
| Maximum Dayer Dissination                           | T <sub>C</sub> = 70 °C      | P <sub>D</sub>                    | 1.77                 | W  |  |
| Maximum Power Dissipation                           | $T_A = 25 ^{\circ}\text{C}$ | ' b                               | 1.78 <sup>b, c</sup> | VV |  |
|   | T <sub>A</sub> = 70 °C      |                                   | 1.14 <sup>b, c</sup> |    |  |
| Operating Junction and Storage Temperature Range    |                             | T <sub>J</sub> , T <sub>stg</sub> | - 55 to 150          | °C |  |

| THERMAL RESISTANCE RATINGS                     |              |                   |         |         |      |  |  |
|--|--------------|-------------------|---------|---------|------|--|--|
| Parameter                                      |              | Symbol            | Typical | Maximum | Unit |  |  |
| Maximum Junction-to-Ambient <sup>a, c, d</sup> | t ≤ 10 s     | R <sub>thJA</sub> | 58      | 70      | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)               | Steady State | $R_{th,IF}$       | 38      | 45      |      |  |  |

#### Notes:

- a. Package limited, T<sub>C</sub> = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 110 °C/W.

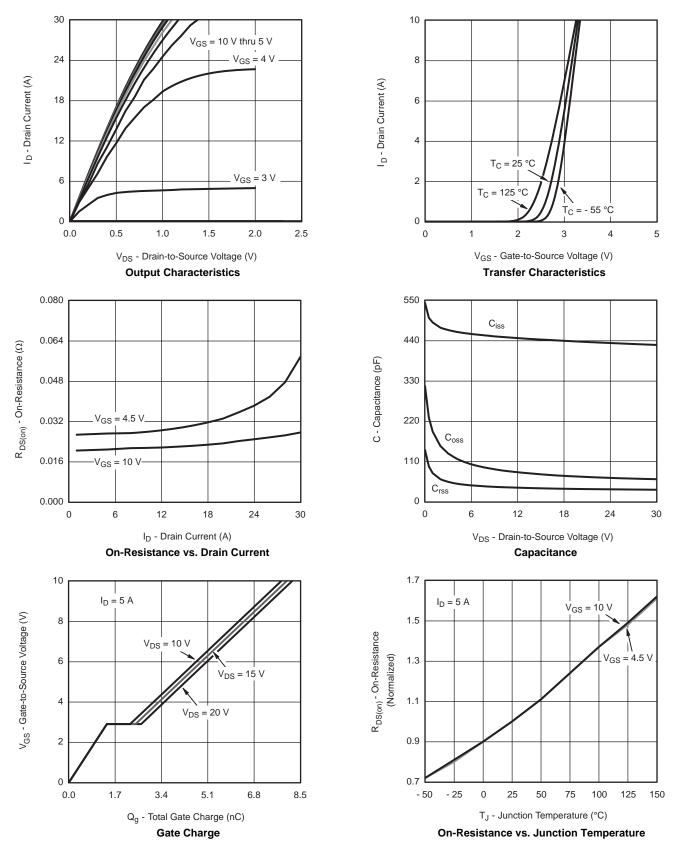


| Parameter                                     | Symbol                  | Test Conditions   | Min. | Тур.  | Max.  | Unit  |
|---|-------------------------|---|------|-------|-------|-------|
| Static  |                         |   | •    |       |       | •     |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$   | 30   |       |       | V     |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | I <sub>D</sub> = 250 μA   |      | 32    |       | mV/°C |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA   |      | - 5.0 |       |       |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$   | 1.0  |       | 2.5   | V     |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$   |      |       | ± 100 | nA    |
| Zara Oata Valla va Daria Oamaal               | I <sub>DSS</sub>        | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$   |      |       | 1     |       |
| Zero Gate Voltage Drain Current               |                         | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C                     |      |       | 10    | μA    |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$   | 10   |       |       | Α     |
|   | 5                       | $V_{GS} = 10 \text{ V, } I_D = 5 \text{ A}$   |      | 0.022 |       | Ω     |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 4.5 \text{ V}, I_D = 4 \text{ A}$   |      | 0.026 |       |       |
| Forward Transconductance <sup>a</sup>         | g <sub>fs</sub>         | $V_{DS} = 10 \text{ V}, I_D = 5 \text{ A}$  |      | 16    |       | S     |
| Dynamic <sup>b</sup>                          | <u> </u>                |   | 1    |       | l     | l     |
| Input Capacitance                             | C <sub>iss</sub>        |   |      | 586   |       | pF    |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$                          |      | 117   |       |       |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |   |      | 55    |       |       |
| Total Gate Charge                             | Q <sub>g</sub>          | $V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$                       |      | 15    |       | nC    |
|   |                         |   |      | 3.7   | 5.6   |       |
| Gate-Source Charge                            | $Q_{gs}$                | $V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 5 \text{ A}$                      |      | 1.4   |       |       |
| Gate-Drain Charge                             | $Q_{gd}$                |   |      | 1.05  |       |       |
| Gate Resistance                               | $R_g$                   | f = 1 MHz   | 0.8  | 4.3   | 8.6   | Ω     |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 12    | 24    |       |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$   |      | 55    | 100   | 1     |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D\cong 5$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$                                     |      | 11    | 22    |       |
| Fall Time                                     | t <sub>f</sub>          |   |      | 8     | 16    |       |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |   |      | 4     | 8     | ns    |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = 15 V, $R_L$ = 3 $\Omega$   |      | 9     | 18    |       |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D\cong 5$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$                                      |      | 10    | 20    |       |
| Fall Time                                     | t <sub>f</sub>          |   |      | 6     | 12    |       |
| <b>Drain-Source Body Diode Characteristic</b> | s                       |   |      |       |       | _     |
| Continuous Source-Drain Diode Current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C  |      |       | 2.25  | ۸     |
| Pulse Diode Forward Current                   | I <sub>SM</sub>         |   |      |       | 24    | Α     |
| Body Diode Voltage                            | $V_{SD}$                | I <sub>S</sub> = 2 A, V <sub>GS</sub> = 0 V   |      | 0.8   | 1.2   | V     |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         |   |      | 11    | 20    | ns    |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         | L _ E A dl/dt _ 100 A/::2 T _ 25 °C   |      | 4     | 8     | nC    |
| Reverse Recovery Fall Time                    | ta                      | $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ |      | 7     |       |       |
| Reverse Recovery Rise Time                    |                         | t <sub>b</sub>  |      | 4     |       | ns    |

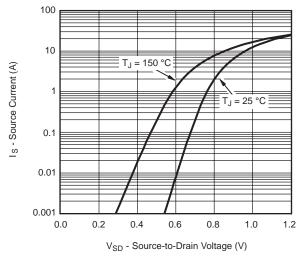
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

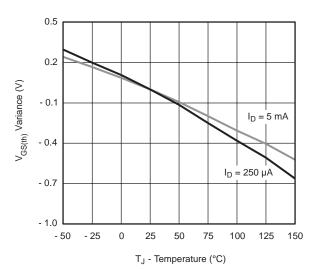




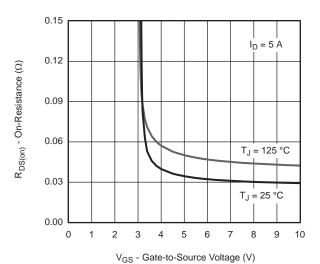




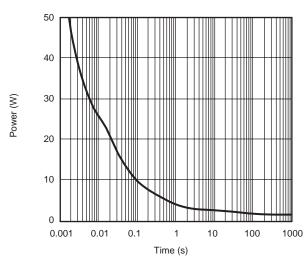
#### Source-Drain Diode Forward Voltage



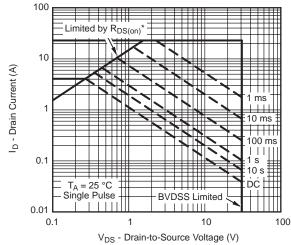
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage



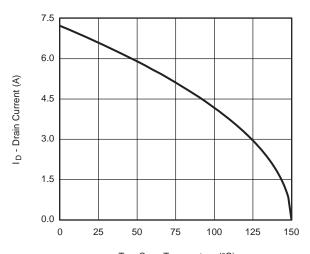
Single Pulse Power



\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

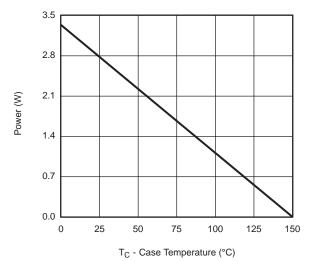
Safe Operating Area, Junction-to-Ambient

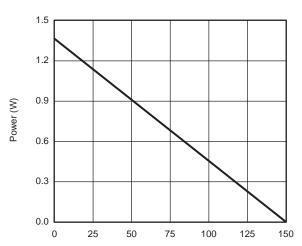




T<sub>C</sub> - Case Temperature (°C)







 $T_A$  - Ambient Temperature (°C)

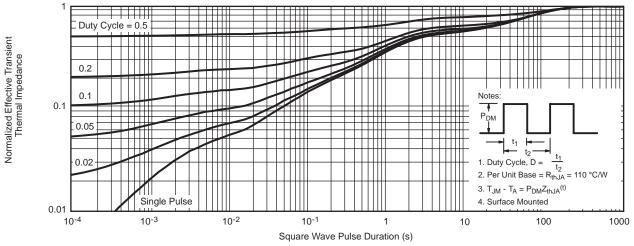
Power, Junction-to-Foot

Power, Junction-to-Ambient

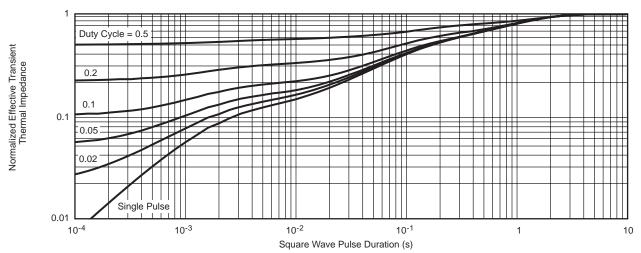
服务热线:400-655-8788 5

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



**SOIC (NARROW): 8-LEAD**JEDEC Part Number: MS-012







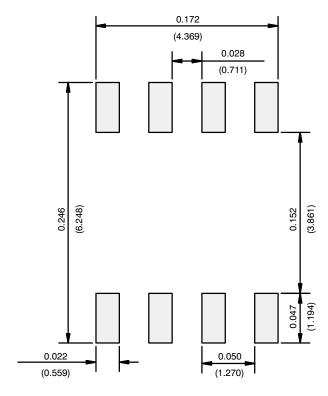
|                                | MILLIMETERS |      | METERS INCHES |       |  |
|--------------------------------|-------------|------|---------------|-------|--|
| DIM                            | Min         | Max  | Min           | Max   |  |
| Α                              | 1.35        | 1.75 | 0.053         | 0.069 |  |
| A <sub>1</sub>                 | 0.10        | 0.20 | 0.004         | 0.008 |  |
| В                              | 0.35        | 0.51 | 0.014         | 0.020 |  |
| С                              | 0.19        | 0.25 | 0.0075        | 0.010 |  |
| D                              | 4.80        | 5.00 | 0.189         | 0.196 |  |
| E                              | 3.80        | 4.00 | 0.150         | 0.157 |  |
| е                              | 1.27 BSC    |      | 0.050 BSC     |       |  |
| Н                              | 5.80        | 6.20 | 0.228         | 0.244 |  |
| h                              | 0.25        | 0.50 | 0.010         | 0.020 |  |
| L                              | 0.50        | 0.93 | 0.020         | 0.037 |  |
| q                              | 0°          | 8°   | 0°            | 8°    |  |
| S                              | 0.44        | 0.64 | 0.018         | 0.026 |  |
| FCN: C-06527-Rev. L. 11-Sep-06 |             |      |               |       |  |

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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